

August 2010

NC7SZ125 TinyLogic[®] UHS Buffer with Three-State Output

Features

- Ultra-High Speed: t_{PD} 2.6ns (Typical) into 50pF at 5V V_{CC}
- High Output Drive: ±24mA at 3V V_{CC}
- Broad V_{CC} Operating Range: 1.65V to 5.5V
- Matches Performance of LCX Operated at 3.3V V_{CC}
- Power Down High-Impedance Inputs/Outputs
- Over-Voltage Tolerance Inputs Facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Space-Saving SOT23 and SC70 Packages

Description

The NC7SZ125 is a single buffer with three-state output from Fairchild's Ultra-High Speed (UHS) of TinyLogic®. The device is fabricated with advanced CMOS technology to achieve ultra high speed with high output drive while maintaining low static power dissipation over a very broad $V_{\rm CC}$ operating range. The device is specified to operate over the 1.65V to 5.5V range. The inputs and output are high impedance above ground when $V_{\rm CC}$ is 0V. Inputs tolerate voltages up to 6V independent of $V_{\rm CC}$ operating voltage. The output tolerates voltages above $V_{\rm CC}$ when in the 3-STATE condition.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7SZ125M5X	7Z25	5-Lead SOT23, JEDEC MO-178 1.6mm	3000 Units on Tape & Reel
NC7SZ125P5X	Z25	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ125L6X	DD	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SZ125FHX	DD	6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

Connection Diagrams

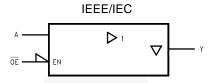
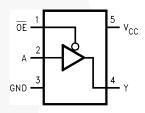


Figure 1. Logic Symbol

Pin Configurations





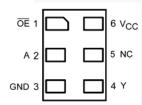


Figure 3. MicroPak™ (Top Through View)

Pin Definitions

Pin # SC70 / SOT23	Pin # MicroPak	Name	Description
1	1	OE	Input
2	2	А	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V _{CC}	Supply Voltage
	5	NC	No Connect

Function Table

Inp	outs	Output
/OE	In A	Out Y
L	L	
L	Н	Н
Н	X	Z

H = HIGH Logic Level

L = LOW Logic Level

X = HIGH or LOW Logic Level

Z = HIGH Impedance State

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	Parameter			Max.	Unit
V _{CC}	Supply Voltage			-0.5	6.0	V
V _{IN}	DC Input Voltage			-0.5	6.0	V
V _{OUT}	DC Output Voltage			-0.5	6.0	V
Luc	DC Input Diodo Current	V _{IN} < -0.5	5V		-50	mA
l _{IK}	DC Input Diode Current	$V_{IN} > 6.0$	V		+20	IIIA
Lavi	DC Output Diada Current	V _{OUT} < -0	.5V		-50	mA
l _{OK}	DC Output Diode Current	V _{OUT} > 6	V, V _{CC} =GND		+20	IIIA
I _{OUT}	DC Output Current				±50	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current				±50	mA
T _{STG}	Storage Temperature Range		1	-65	+150	°C
TJ	Junction Temperature Under Bi	as			+150	°C
TL	Junction Lead Temperature (Sc	oldering, 10 Second	ls)		+260	°C
		SOT-23			200	
P_{D}	Dower Dissipation at 195°C	SC70-5			150	m\\/
PD	Power Dissipation at +85°C	MicroPak	c-6	\	130	mW
		MicroPak	2-6		120	
ESD	Human Body Model, JESD22-A114				4000	V
ESD	Charged Device Model, JESD2	2-C101			2000	V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V _{CC}	Supply Voltage Operating		1.65	5.50	V	
V CC	Supply Voltage Data Retention		1.50	5.50	7 v	
V _{IN}	Input Voltage		0	5.5	V	
M	Output Voltage	Active State	0	V _{cc}	V	
V _{OUT}	Output Voltage	Three-State	0	5.5	7 V	
T _A	Operating Temperature		-40	+85	°C	
		V _{CC} at 1.8V, 2.5V ± 0.2V	0	20	\prec	
t_r, t_f	Input Rise and Fall Times	V _{CC} at 3.3V ± 0.3V	0	10	ns/V	
		V _{CC} at 5.0V ± 0.5V	0	5		
		SOT-23		300		
0	The survey I Description of	SC70-5		425	°C/W	
$\theta_{\sf JA}$	Thermal Resistance	MicroPak-6		500		
		MicroPak2-6		560		

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

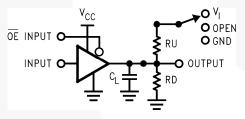
0		.,		Т,	4=+25°	C	T _A =-40 t	o +85°C	
Symbol Parameter V _C		V _{CC}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
.,	HIGH Level	1.65 to 1.95		0.75V _{CC}			0.75V _{CC}		.,
V_{IH}	Input Voltage	2.30 to 5.50		0.70V _{CC}			0.70V _{CC}		V
	LOW Level	1.65 to 1.95				0.25V _{CC}		0.25V _{CC}	.,
V_{IL}	Input Voltage	2.30 to 5.50				0.30V _{CC}		0.30V _{CC}	V
		1.65		1.55	1.65		1.55		
		1.80		1.70	1.80		1.70		
		2.30	V _{IN} =V _{IH} , I _{OH} =-100μA	2.20	2.30		2.20		V
		3.00		2.90	3.00		2.90		
	HIGH Level	4.50		4.40	4.50		4.40		
V_{OH}	Output Voltage	1.65	I _{OH} =-4mA	1.29	1.52		1.29		
		2.30	I _{OH} =-8mA	1.90	2.15		1.90		
		3.00	I _{OH} =-16mA	2.40	2.80		2.40		
		3.00	I _{OH} =-24mA	2.30	2.68		2.30		
		4.50	I _{OH} =-32mA	3.80	4.20		3.80		
		1.65	<u> </u>		0.00	0.10		0.00	
		1.80			0.00	0.10		0.10	
	1/4	2.30	V _{IN} =V _{IL} , I _{OL} =100μA		0.00	0.10		0.10	<u> </u>
		3.00	•		0.00	0.10		0.10	
	LOW Level	4.50			0.00	0.10		0.10	
V_{OL}	Output Voltage	1.65	I _{OL} =4mA		0.80	0.24		0.24	V
		2.30	I _{OL} =8mA		0.10	0.30		0.30	
		3.00	I _{OL} =16mA		0.15	0.40		0.40	
		3.00	I _{OL} =24mA		0.22	0.55		0.55	
		4.50	I _{OL} =32mA		0.22	0.55		0.55	
I _{IN}	Input Leakage Current	0 to 5.5	$0 \ge V_{\text{IN}} \ge 5.5 V$			±1	/	±10	μA
l _{OZ}	3-STATE Output Leakage	0 to 5.5	$V_{IN}=V_{IH}$ or V_{IL} $0 \ge V_O \ge 5.5V$			±1		±10	μΑ
l _{OFF}	Power Off Leakage Current	0	V _{IN} or V _{OUT} =5.5V			1		10	μA
I _{CC}	Quiescent Supply Current	1.65 to 5.50	V _{IN} =5.5V, GND			2		20	μA

AC Electrical Characteristics

Compleal	Donomoton	Parameter V _{cc}		Т	_A =+25°	°C	T _A =-40 1	to +85°C	Units	Eiguro
Symbol	Parameter	V CC	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Figure
		1.65		2.0	6.4	13.2	2.0	13.8		
		1.80	C _L =15pF,	2.0	5.3	11.0	2.0	11.5		
		2.50 ± 0.20	$R_D=1M\Omega$	0.8	3.4	7.5	0.8	8.0		
t _{PLH} ,t _{PHL}	Propagation Delay	3.30 ± 0.30	S ₁ =OPEN	0.5	2.5	5.2	0.5	5.5	ns	Figure 4
YELH, YEHL	. ropaganon zolaj	5.00 ± 0.50		0.5	2.1	4.5	0.5	4.8	1.0	Figure 6
		3.30 ± 0.30	C _L =50pF,	1.5	3.2	5.7	1.5	6.0		
		5.00 ± 0.50	$R_D=500\Omega$ $S_1=OPEN$	0.8	2.6	5.0	0.8	5.3		
		1.65	C _L =50pF,	2.0	8.4	15.0	2.0	15.6		
		1.80	$R_D=500\Omega$ $RU=500\Omega$ $S_1=GND \text{ for } t_{PZH}$	2.0	7.0	12.5	2.0	13.0		
$t_{PZL,}t_{PZH}$	Output Enable Time	1 7.50 + 0.70 1		1.5	4.6	8.5	1.5	9.0		
		3.30 ± 0.30	S ₁ =GND 101 tPZH S ₁ =V _{IN} for t _{PZL}	1.5	3.5	6.2	1.5	6.5		
		5.00 ± 0.50	V _{IN} =2•V _{CC}	0.8	2.8	5.5	0.8	5.8		Figure 4
		1.65	C _L =50pF,	2.0	6.5	13.2	2.0	14.5	ns	Figure 6
		1.80	$R_D=500\Omega$	2.0	5.4	11.0	2.0	12.0		
$t_{\text{PLZ}}, t_{\text{PHZ}}$	Output Disable Time	2.50 ± 0.20	RU=500 Ω S ₁ =GND for t _{PHZ}	1.5	3.5	8.0	1.5	8.5		
		S ₁ =GND for t _{PHZ}	1.0	2.8	5.7	1.0	6.0			
		5.00 ± 0.50	V _{IN} =2•V _{CC}	0.5	2.1	4.7	0.5	5.0		
C _{IN}	Input Capacitance	0.00			4				pF	
C_{OUT}	Output Capacitance	0.00	_		8					
0	Power Dissipation	3.30			17					Ciaura C
CPD	C _{PD} Capacitance ⁽²⁾				24				pF	Figure 5

Note:

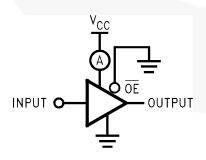
2. C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output lading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}static).



Note:

3. C_L includes load and stray capacitance. Input PRR=1.0MHz, t_W =500ns.

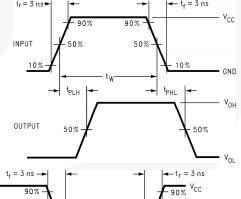
Figure 4. AC Test Circuit

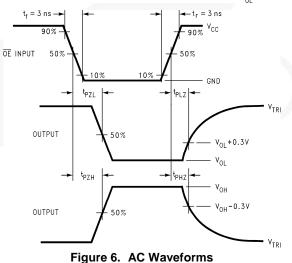


Note:

 Input=AC Waveform; t_r=t_f=1.8ns; PRR=10MHz; Duty Cycle=50%.

Figure 5. I_{CCD} Test Circuit





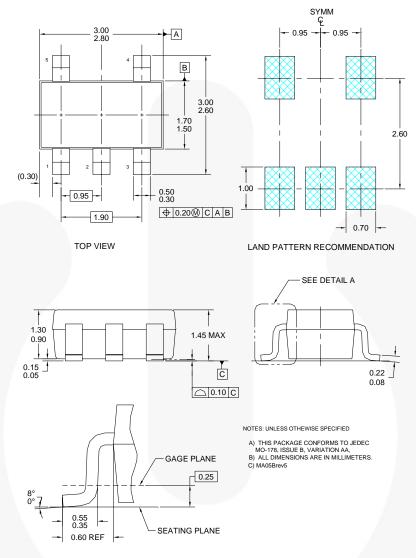


Figure 7. 5-Lead SOT23, JEDEC MO-178 1.6mm

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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/packaging/SOT23-5L_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

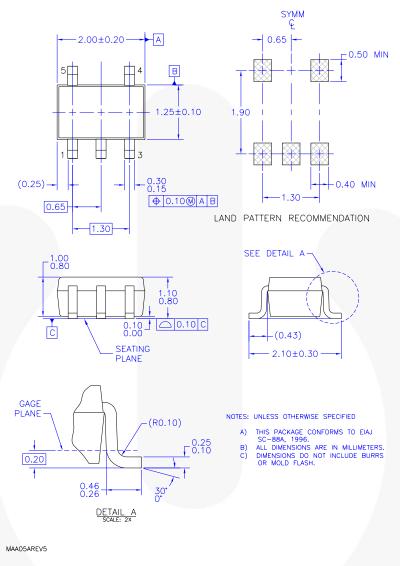


Figure 8. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

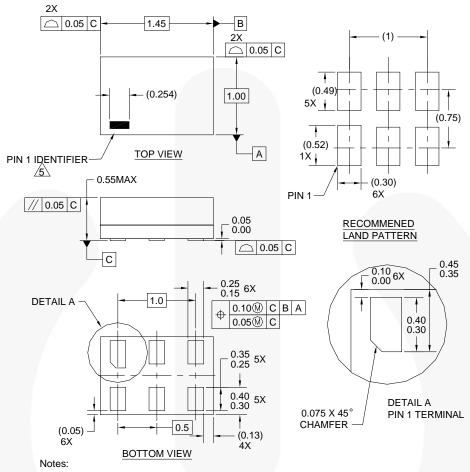
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Tape and Reel Specifications

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications: http://www.fairchildsemi.com/products/analog/pdf/sc70-5 tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



- 1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994
- 4. FILENAME AND REVISION: MAC06AREV4
- ©PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 9. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specifications

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

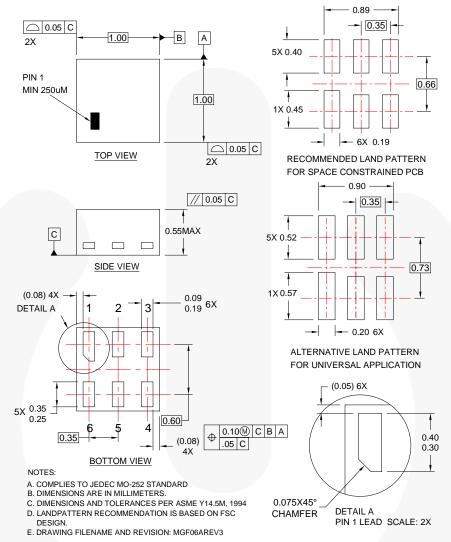


Figure 10. 6-Lead, MicroPak2, 1x1mm Body, .35mm Pitch

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





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